

RZ/A2M Group

DRP Driver User's Manual

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General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual

34 The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- 3/4 The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
 In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.
- 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

3/4 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

34 The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

How to Use This Manual

1. Purpose and Target Readers

This manual is intended to provide the user with an understanding of the functions of the DRP driver software and how to utilize them. It is aimed at users designing application systems making use of the software. In order to use this manual, you will need a basic knowledge of programming languages and microprocessors.

Particular attention should be paid to the precautionary notes when using the software. These notes occur within the body of the text, and at the end of each section.

The revision history summarizes the locations of revisions and additions. It does not list all revisions. Refer to the text of the manual for details.

Table of Contents

1.	Introd	luction	1
		Summary	
1.1 1.2		Functions	
J	1.3	Software Configuration	2
2.	Oper	ation Conditions	3
	·		
3.	File S	Structure	<i>\</i>
4.	API S	Specifications	5
4	l.1	List of API Functions	5
4	1.2	Error Codes	
5.	API F	Reference	6
5	5.1	How to Read the API Reference	<i>6</i>
5	5.2	R_DK2_Initialize	7
5	5.3	R_DK2_Uninitialize	
5	5.4	R_DK2_Load.	9
	5.4.1	Tile Patterns	13
	5.4.2	Load Completion Callback Function	14
5	5.5	R_DK2_Unload	
5	5.6	R_DK2_Activate	16
5	5.7	R_DK2_Inactivate	17
5	5.8	R_DK2_Start	18
	5.8.1	Processing Completion Callback Function	19
5	5.9	R_DK2_GetStatus	20
5	5.10	R_DK2_GetInfo	21
5	5.11	R_DK2_GetVersion.	
6.	State	Transitions	24
6	5.1	State Transitions of the DRP Driver Overall	24
6	5.2	State Transitions of Individual Circuits	25

7.	Control Flowchart	26
8.	OS-Dependent Portion	27
9.	Reference Documents	28



RZ/A2M Group DRP Driver User's Manual

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1. Introduction

1.1 Summary

This manual describes the functions and usage of the DRP driver software, which controls the dynamic reconfigurable processor (DRP) of RZ/A2M Group microprocessors.

1.2 Functions

DRP can be implemented a variety of functions corresponding to user's setting. In this manual the function implemented by DRP is referred to as "circuit" and the data representing the circuit information is referred to as "configuration data."*¹ The configuration data consists of binary data allocated in the memory.

As a device driver for the DRP, the DRP driver performs the following functions:

- Supplies a clock to the DRP and initializes the DRP driver.
- Stops supply of the clock to the DRP and terminates the DRP driver.
- Loads configuration data in the DRP.
- Erases configuration data loaded in the DRP. (Calls "unload" in this document.)
- Supplies a clock to and enables circuits written to the DRP.
- Stops supply of the clock to and disables circuits written to the DRP.
- Sets operation parameters of circuits written to the DRP and starts operation.
- Provides notification of operation completion by circuits written to the DRP.
- Gets the status (enabled or disabled, operating or not, etc.) of circuits written to the DRP.
- Gets information (version, etc.) from configuration data in the memory.
- Performs CRC checks on configuration data in the memory.

Note 1. Configuration data provided as DRP library. For details of DRP library, refer to RZ/A2M Group DRP Library User's Manual (R01US0367).

RZ/A2M Group 1. Introduction

1.3 Software Configuration

The software configuration of the DRP driver is shown below. The DRP driver comprises an interface portion and a core portion, and both are supplied as source code. The DRP driver supports FreeRTOS via an OS abstraction layer.

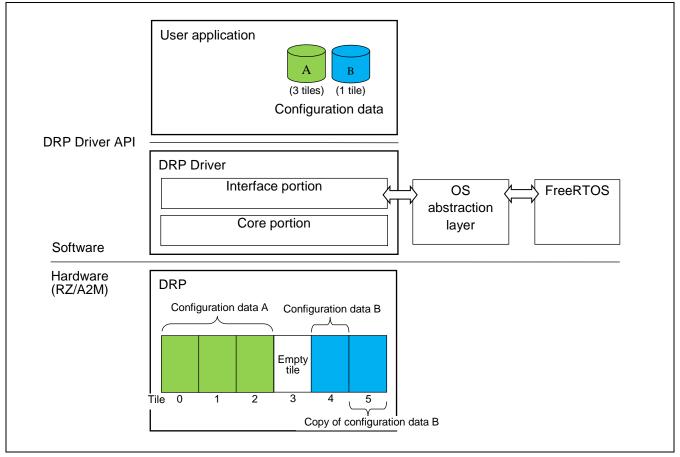


Figure 1.1 Software Configuration

- The DRP has six memory areas called "tiles" for loading configuration data.
- Configuration data is loaded in tile units.
- Each item of configuration data has its own tile count, represented as an integer value between 1 and 6. The tile count represents the number of tiles occupied by the configuration data.
- If the configuration data has a tile count of 3 or less, multiple copies can be loaded at the same time.
- In this manual the six tiles of the DRP are referred to as tile 0 to tile 5.
- In the figure above, one copy of configuration data A with tile count 3 is loaded in tile 0 through tile 2, and two copies of configuration data B with tile count 1 are loaded in tile 4 and tile 5, respectively.

RZ/A2M Group 2. Operation Conditions

2. Operation Conditions

The DRP driver operates under the conditions listed below.

Table 2.1 Operation Conditions

Item	Description		
Microprocessor	The DRP driver runs on the Cortex TM -A9 processor of RZ/A2M Group microprocessors. The product numbers of compatible RZ/A2M Group microprocessors are as follows:*1		
	R7S921051VCBG		
	R7S921052VCBG		
	R7S921053VCBG		
Development environment	e ² studio V7.1.0		
	The following toolchain is compatible:		
	GNU Arm Embedded Toolchain 6-2017-q2-update		

Note 1. The DRP driver operates on RZ/A2M Group microprocessors equipped with a DRP function module. It will not operate on RZ/A2M Group microprocessors without a DRP function module.

RZ/A2M Group 3. File Structure

3. File Structure

Figure 3.1 shows the file structure of the DRP driver.

```
src
    renesas
         drivers
             drp
                  inc
                      r_dk2_if.h
                                             Header file of DRP Driver interface part
                  src
                       drp_iodefine.h
                                             IO definition file of DRP
                      r_dk2_core.c
                                             Source file of DRP Driver core part
                      r_dk2_core.h
                                             Header file of DRP Driver core part
                      r_dk2_if.c
                                             Source file of DRP Driver interface part
```

Figure 3.1 The File Structure of The DRP Driver

RZ/A2M Group 4. API Specifications

4. API Specifications

4.1 List of API Functions

Table 4.1 lists the API functions of the DRP driver.

Table 4.1 API Functions of DRP Driver

API Function Name	Outline	Page
R_DK2_Initialize	Initializes DRP driver and initializes DRP.	7
R_DK2_Uninitialize	Stops DRP and terminates DRP driver.	8
R_DK2_Load	Loads configuration data in DRP.	9
R_DK2_Unload	Unloads configuration data from DRP.	15
R_DK2_Activate	Enables circuit in DRP.	16
R_DK2_Inactivate	Disables circuit in DRP.	17
R_DK2_Start	Starts operation of circuit in DRP.	18
R_DK2_GetStatus	Gets state of circuit in DRP.	20
R_DK2_GetInfo	Gets information from configuration data and checks CRC.	21
R_DK2_GetVersion	Gets DRP driver version information.	23

None of the API functions may be called from an interrupt context. For information on the reentrancy of API functions, refer to section 8. OS-Dependent Portion.

4.2 Error Codes

A return value of 0 or a positive number from a DRP driver API function indicates a normal end, and a negative return value indicates an abnormal end. When an abnormal end occurs, an error code is returned. Table 4.2 lists the error codes. For the specific conditions under which errors are generated, refer to the descriptions of the return values of the various API functions in section 5. API Reference.

Table 4.2 Function Error Codes

Macro Name	Value	Description
R_DK2_SUCCESS	0	Normal end
R_DK2_ERR_ARG	-1	Argument error
R_DK2_ERR_FORMAT	-2	Format error
R_DK2_ERR_CRC	-3	CRC error
R_DK2_ERR_DEVICE	-4	Device error
R_DK2_ERR_BUSY	-5	Busy
R_DK2_ERR_INTERNAL	-6	Internal error
R_DK2_ERR_OVERWRITE	-7	Data overwrite error
R_DK2_ERR_OS	-8	OS error
R_DK2_ERR_STATUS	-9	Status error
R_DK2_ERR_TILE_PATTERN	-10	Tile pattern error
R_DK2_ERR_STOPPED	-11	Transfer stopped error

5. API Reference

5.1 How to Read the API Reference

API function name				
Function outline	Synchronous/asynchronous function			
Format Shows the format used to call the API function. The header file designated by #include "header file" is the standard header file required to run the API function. Do not fail to it this header file. The designations I and O indicate that the corresponding argument is it data or output data, respectively. The designation IO indicates input/output data.				
Return values	Lists the return values of the API function. Comments following the colon (:) after the return value provide a description of the return value (such as return conditions).			
Description	Describes the specifications of the API function.			
Note	Any precautionary notes appear here.			

5.2 R_DK2_Initialize

R DK2 Initialize			DRP driver API		
Initializes DRP driver and initializes DRP			Synchronous function		
Format	#include "r_dk2_if.h"				
	int32_t R_DK2_Initialize(vo	oid);			
Return value	es R_DK2_SUCCESS	:	Normal end.		
	R_DK2_ERR_DEVICE	:	Abnormal end.		
			This error is generated when initialization of the DRP fails.		
	R_DK2_ERR_OS	:	Abnormal end.		
			This error is generated when securing of an OS resource		
			fails.		
	R_DK2_ERR_STATUS	:	Abnormal end.		
			This error is generated when the DRP driver has already been initialized.		
Description	This API function initializes	interna	al variables and secures OS resources, putting the DRP driver		
	into a usable state. Also, it restores the DRP from low-power mode, starts supply of the clock,				
	and initializes the hardware	Э.			
Note	If the error R_DK2_ERR_DEVICE occurs, check the device used. The DRP driver is compatible				
	with RZ/A2M Group microprocessors equipped with a DRP function module. For details of the				
			refer to section 2. Operation Conditions. If the value		
R_DK2_ERR_OS is returned, reevaluate the OS settings.			valuate the OS settings.		

5.3 R_DK2_Uninitialize

R DK2	Uninitialize	DRP driver API
	and terminates DRP driver	Synchronous function
Format	#include "r_dk2_if.h"	
	int32_t R_DK2_Uninitalize(void)	•
Return value	es R_DK2_SUCCESS :	Normal end.
	R_DK2_ERR_OS :	Abnormal end.
		This error is generated when releasing of an OS resource
		fails.
	R_DK2_ERR_STATUS :	Abnormal end.
		This error is generated when the DRP driver has already
		been terminated.
Description This API function stops supply of the clock to the DRP and transitions the DF		f the clock to the DRP and transitions the DRP to low-power
	if the DRP is operating. Also, it releases OS resources and	
transitions the DRP driver to the uninitialized state. After this API function runs, the		
	remains in an unusable state un	til the next time the R_DK2_Initialize function is called.
Note This API function performs a forced stop if the DRP		ced stop if the DRP is operating. Note that in this case the
	K2_Load function may not be called.	
If the value R_DK2_ERR_OS is returned, reevaluate the OS settings.		

5.4 R_DK2_Load

R DK2 Load

DRP driver API

Loads configuration data in DRP

Synchronous/asynchronous function

Format

#include "r_dk2_if.h"

int32_t R_DK2_Load(const void *const pconfig, const uint8_t top_tiles, const uint32_t tile_pattern, const load_comp_t pload, const process_comp_t pprocess, uint8_t *const paid);

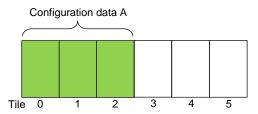
pconfig	I	Specifies the address of the configuration data to be
		loaded. The configuration data must be aligned with a
		32-byte boundary. Also, the configuration data must
		exist in physical memory.

top_tiles

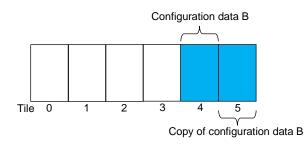
I Specifies the start tile position where the configuration data is allocated using macros R_DK2_TILE_0 to R_DK2_TILE_5, which represent the six tiles of the DRP, tile 0 to tile 5. When loading multiple configuration

DRP, tile 0 to tile 5. When loading multiple configuration data items, obtain the logical sum (logical OR) of each bit of the above macros.

For example, to allocate configuration data A with tile count 3 to tile 0 through tile 2, specify "R_DK2_TILE0".



For example, to allocate two copies of configuration data B with tile count 1 to tile 4 and tile 5, respectively, specify "R_DK2_TILE_4 | R_DK2_TILE_5".



tile_pattern

I Specifies the tile pattern. For setting values, refer to 5.4.1, Tile Patterns. Once the tile pattern has been set, use the same tile pattern setting until the configuration data for all tiles has been unloaded using the R_DK2_Unload function. When an attempt is made to change the tile pattern when the DRP is in a state in which configuration data has already been loaded, the API function returns a value of R_DK2_ERR_TILE_PATTERN.

pload	I Specifies the address of the callback function used to provide notification when loading of configuration data completes. For detailed specifications of the callback function specified by the argument pload, refer to 5.4.2, Load Completion Callback Function. When a value other than NULL is specified for this argument, loading of configuration data can be halted by the R_DK2_Unload function. When NULL is specified for this argument, the R_DK2_Unload function cannot halt loading of configuration data, and this API function finishes only when loading is complete.
pprocess	I Specifies the address of the callback function used to provide notification when the processing started using the R_DK2_Start function completes. For detailed specifications of the callback function specified by the argument pprocess, refer to 5.8.1, Processing Completion Callback Function. This notification does not occur if NULL is specified.
paid	O Specifies the address of the six-element array used to perform notification of the ID for identifying the loaded configuration data. Index 0 to index 5 of the array represent the six tiles of the DRP, tile 0 to tile 5, and the array elements represent the IDs of the configuration data items loaded in the corresponding tiles. If a configuration data item occupies multiple tiles, the same ID is stored in all the array elements representing the corresponding tiles. Each ID is a unique positive number corresponding to a single circuit, and a value of 0 means that no configuration data is loaded. If multiple copies of a configuration data item are loaded, each copy is assigned a different ID. When notification of IDs is made by this argument, the notification covers the IDs for all six tiles following execution of the R_DK2_Load function, including all configuration data that has been written to that point. This notification does not occur if NULL is specified.

For example, if configuration data A with tile count 3 is allocated to tile 0 through tile 2, and two copies of configuration data B with tile count 1 are allocated to tile 4 and tile 5, respectively, the contents of the array are as shown below.

as shown selecti				
Index	Description			
0	Circuit ID of configuration data A circuit			
	information			
1	Same as index 0			
2	Same as index 0			
3	0			
4	Circuit ID of configuration data B circuit			
	information			
5	Circuit ID of configuration data B circuit			
	information (different from index 4)			

Return values R_DK2_SUCCESS	:	Normal end.
R_DK2_ERR_ARG	:	Abnormal end.
		This error is generated in the following cases:
		 NULL is specified for argument pconfig.
		 A value that is not aligned with a 32-byte boundary is specified for argument pconfig.
		 The argument top_tiles is not in the format of the
		logical sum (logical OR) of each bit of
		R_DK2_TILE_0 to R_DK2_TILE_5.
		 A macro other than those listed in Table 5.1 is
		specified for argument tile_pattern.
R_DK2_ERR_FORMAT	:	Abnormal end.
		This error is generated when a format error is detected in the configuration data.
R_DK2_ERR_DEVICE	:	Abnormal end.
		This error is generated when NULL is specified for
		argument pload and a transfer error occurs during
D DV2 EDD DUCY		loading of configuration data. Abnormal end.
R_DK2_ERR_BUSY	:	This error is generated when a value other than NULL is specified for argument pload and, during loading of configuration data, an attempt is made to load other configuration data.
R_DK2_ERR_OVERWRITE	:	Abnormal end.
		This error is generated when other configuration data has already been written to the load position of the specified configuration data.
R_DK2_ERR_OS	:	Abnormal end.
		This error is generated when exclusive control by the OS fails.
R_DK2_ERR_STATUS	:	Abnormal end.
		This error is generated when the DRP driver has not
		been initialized.
R_DK2_ERR_TILE_PATTER	N:	Abnormal end.
		This error is generated in the following cases:
		 The tile pattern is changed when the DRP is in a state in which configuration data has already been loaded.
		 The tile position or tile count in the configuration data do not match the tile pattern.

Description

When a value other than NULL is specified for the argument pload, this API function starts loading the configuration data in the DRP and notifies when loading completes by means of a callback function. At this time, other configuration data cannot be loaded until loading completes. In such cases the value R_DK2_ERR_BUSY is returned, and this API function fails. Also, if a value other than NULL is specified for the argument pload, it is possible to halt loading of configuration data with the R_DK2_Unload function.

When NULL is specified for the argument pload, loading of the configuration data continues until completion when this API function is run. In this case, loading of configuration data cannot be halted by the R_DK2_Unload function.

It is also possible for this API function to load configuration data to multiple tile positions. For details of the callback function specified by the argument pload, refer to 5.4.2, Load Completion Callback Function, and for details of the callback function specified by the argument pprocess, refer to 5.8.1, Processing Completion Callback Function.

This API function uses OS functionality to provide exclusive control so that multiple DRP driver API functions are not executed at the same time. If a failure occurs because resource acquisition times out during exclusive control, the value R_DK2_ERR_OS is returned and the API function fails.

Note

If the value R_DK2_ERR_FORMAT is returned, check to make sure the address specified for argument pconfig is the correct address of the configuration data.

A return value of R_DK2_ERR_DEVICE indicates that an error occurred during transfer of the configuration data. Reevaluate the memory settings, etc., for the allocation of the configuration data.

If the configuration data specified by the argument pconfig exists in the Cortex-A9 cache and the data in the physical memory does not match the configuration data, proper loading will not be possible. It may be necessary to clear the cache before calling this API function or to allocate the configuration data to a non-cached area.

5.4.1 Tile Patterns

The tile count and tile position combinations used when loading configuration data in the DRP are limited to the 11 patterns listed in Table 5.1. Set the appropriate macro value below in the argument tile_pattern of the R_DK2_Load function to match the combination to be used.

Table 5.1 Tile Patterns

Tile Pattern	Macro Setting of Argument tile_pattern of R_DK2_Load Function			
1 1 1 1 1	R_DK2_TILE_PATTERN_1_1_1_1_1			
2 1 1 1 1	R_DK2_TILE_PATTERN_2_1_1_1			
2 2 1 1	R_DK2_TILE_PATTERN_2_2_1_1			
2 2 2	R_DK2_TILE_PATTERN_2_2_2			
3 1 1 1	R_DK2_TILE_PATTERN_3_1_1_1			
3 2 1	R_DK2_TILE_PATTERN_3_2_1			
3 3	R_DK2_TILE_PATTERN_3_3			
4 1 1	R_DK2_TILE_PATTERN_4_1_1			
4 2	R_DK2_TILE_PATTERN_4_2			
5 1	R_DK2_TILE_PATTERN_5_1			
6	R_DK2_TILE_PATTERN_6			

n : Configuration data with tile count n

5.4.2 Load Completion Callback Function

Load co	mpletion call	back fund	ction Callback function	
	of loading of configura		Synchronous function	
Format	#include "r_dk2_if.h)"		
	void load_comp(uin	t8_t id, int32_t	result);	
	Note: This function	can be given a	iny name.	
	id		ID of circuit that has finished loading	
	result		R_DK2_SUCCESS:	
			Indicates that loading has completed successfully.	
			R_DK2_ERR_DEVICE:	
			Indicates that a transfer error occurred while loading	
			configuration data.	
			R_DK2_ERR_STOPPED:	
			Indicates that while loading configuration data the transfer was stopped by calling the R_DK2_Unload function.	
Return value	es None			
Description	provides notification	when the load	fied by the argument pload of the R_DK2_Load function. It ding of configuration data finishes. When multiple	
	configuration data items are loaded, this callback function is called once for each item loaded.			
	This function is exe function.	cuted in the int	terrupt context. This function must not call any DRP driver	
Note	If the value of the a etc., for the allocation	•	is R_DK2_ERR_DEVICE, reevaluate the memory settings, guration data.	

5.5 R_DK2_Unload

R_DK2_	Unload		DRP driver API
	iguration data from DRP		Synchronous function
Format	#include "r_dk2_if.h"		
	int32_t R_DK2_Unload(con	st uint	8_t id, uint8_t *const paid);
	id	I	Specifies the ID of the circuit to be unloaded. To unload multiple circuits, specify the logical sum (logical OR) of each bit of the IDs of each of the circuits. Specifying 0 causes all loaded circuits to be unloaded.
	paid	0	To obtain notification of the DRP load status following execution of this function, specify the address of a six-element array prepared by the user. Index 0 to index 5 of the array represent the six tiles of the DRP, tile 0 to tile 5, and the array elements represent the IDs of the configuration data items loaded in the corresponding tiles. If a configuration data item occupies multiple tiles, the same ID is stored in all the array elements representing the corresponding tiles. This ID is a unique positive number corresponding to a single circuit, and a value of 0 means that no configuration data is loaded. If multiple copies of the same configuration data item are loaded, each copy is assigned a different ID. When notification of IDs is made by this argument, the notification covers the IDs for all six tiles following execution of the R_DK2_Unload function, including all configuration data that has been written to that point. This notification does not occur if NULL is specified.
Return values	s R_DK2_SUCCESS	:	Normal end.
	R_DK2_ERR_ARG	:	Abnormal end. This error is generated when the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS	:	Abnormal end. This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	:	Abnormal end. This error is generated in the following cases: The DRP driver has not been initialized.
Description	circuit is unloaded, configur API function will forcibly unloperating. If this API function is called the callback function specifi this point, the value of the cif if this API function is called function specified by the pp the value of the callback function	ation of coad the during ed by allback during rocess action?	uit corresponding to the specified ID from the DRP. After the lata can once again be loaded in the same tile position. This e circuit even if it is in the process of being loaded or if it is loading of configuration data, loading of data is canceled and the pload argument of the R_DK2_Load function is called. At k function's result argument is R_DK2_ERR_STOPPED. Also, circuit operation, the circuit stops operating and the callback argument of the R_DK2_Load function is called. At this point, is result argument is R_DK2_ERR_STOPPED.
	This API function uses OS to API functions are not executacquisition times out during API function fails.	unctio	le circuits or all currently loaded circuits. nality to provide exclusive control so that multiple DRP driver the same time. If a failure occurs because resource sive control, the value R_DK2_ERR_OS is returned and the
Note	None.		

5.6 R_DK2_Activate

R DK2	Activate		DRP driver API
Enables circ			Synchronous function
Format	#include "r_dk2_if.h" int32_t R_DK2_Activate(co	nst uin	t8_t id, const uint32_t freq);
	id	I	Specifies the ID of the circuit to be enabled. To enable multiple circuits, specify the logical sum (logical OR) of each bit of the IDs of each of the circuits. Specifying 0 causes all loaded circuits to be enabled.
	freq		Specifies 0.
Return value	s R_DK2_SUCCESS	:	Normal end.
	R_DK2_ERR_ARG	:	Abnormal end.
			This error is generated when the value of the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS	:	Abnormal end. This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	:	Abnormal end.
			This error is generated in the following cases:
			 The DRP driver has not been initialized.
			 The circuit specified by the argument id is not in the loaded state.
			 0 was specified for the argument id and no circuit is currently in the loaded state.
			(For information on circuit states, refer to 6.2, State Transitions of Individual Circuits.)
Description			currently loaded in the DRP, supplies a clock to the
	corresponding tile, and put		
	as the argument id in order	to ena	ble circuits or all currently loaded circuits. When 0 is specified ble all circuits, only circuits currently in the loaded state are it states, refer to 6.2, State Transitions of Individual Circuits.)
	This API function uses OS API functions are not executed as the contract of th	function	nality to provide exclusive control so that multiple DRP driver the same time. If a failure occurs because resource sive control, the value R_DK2_ERR_OS is returned and the
Note	None.		

5.7 R_DK2_Inactivate

R DK2	_Inactivate	DRP driver API
Disables circ		Synchronous function
Format	#include "r_dk2_if.h" int32_t R_DK2_Inactivate(con	st uint8 t id):
	id	I Specifies the ID of the circuit to be disabled. To disable multiple circuits, specify the logical sum (logical OR) of each bit of the IDs of each of the circuits. Specifying 0 causes all loaded circuits to be disabled.
Return value	es R_DK2_SUCCESS	: Normal end.
	R_DK2_ERR_ARG	Abnormal end. This error is generated when the value of the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS	: Abnormal end. This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	 Abnormal end. This error is generated in the following cases: The DRP driver has not been initialized. The circuit specified by the argument id is not in the activated or started state.
		0 was specified for the argument id and no circuit is currently in the activated or started state. (For information or circuit at the profests 6.2. State)
		(For information on circuit states, refer to 6.2, State Transitions of Individual Circuits.)
Description	corresponding tile, and puts th	ircuit currently loaded in the DRP, stops supply of the clock to the ne circuit into the low-power state.
		ultiple circuits or all currently loaded circuits. When 0 is specified disable all circuits, only circuits currently in the activated or
	API functions are not executed	actionality to provide exclusive control so that multiple DRP driver d at the same time. If a failure occurs because resource colusive control, the value R_DK2_ERR_OS is returned and the
Note	None	

5.8 R_DK2_Start

R_DK2_	Start	DRP driver API
	tion of circuit in DRP	Asynchronous function
Format	#include "r_dk2_if.h"	
	int32_t R_DK2_Start(const	uint8_t id, const void *const pparam, const uint32_t size);
	id	I Specifies the ID of the circuit that will start operating.
	pparam	I Specifies the area for storing parameters for circuit operation. The area where parameters are stored must exist in physical memory. The parameter storage area for each circuit is read independently, so it is not possible for one area to be shared by multiple circuits. The parameter specifications are different for each
		configuration data. For the parameter specifications of each configuration data, refer to RZ/A2M Group DRP Library User's Manual (R01US0367).
	size	I Specifies the size of the parameter area specified by the argument pparam.
Return value	es R_DK2_SUCCESS	: Normal end.
	R_DK2_ERR_ARG	: Abnormal end.
		This error is generated in the following cases:
		 The value of the argument id does not correspond to a circuit currently loaded in the DRP.
		 NULL is specified for the argument pparam.
		 0 is specified for the argument size.
	R_DK2_ERR_OS	: Abnormal end.
		This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	: Abnormal end.
		This error is generated in the following cases:
		 The DRP driver has not been initialized.
		 The circuit specified by the argument id is not in the activated state.
		(For information on circuit states, refer to 6.2, State Transitions of Individual Circuits.)
Description	of processing is provided by argument pprocess of the R callback function, refer to 5.	ration of a circuit loaded in the DRP. Notification of the completion the processing completion callback function specified by the DK2_Load function. For details of the processing completion 8.1, Processing Completion Callback Function.
	API functions are not execu	unctionality to provide exclusive control so that multiple DRP driver ted at the same time. If a failure occurs because resource exclusive control, the value R_DK2_ERR_OS is returned and the
Note	the circuit's I/O data exists in physical memory do not r	re the area set by the argument pparam for storing parameters or in the cache of the Cortex-A9, and the parameters or circuit I/O data match, the circuit will not operate properly. It may be necessary to ing this API function or to allocate the parameters and circuit I/O data

5.8.1 Processing Completion Callback Function

Process	sing completion	n callbac	k function	Callback function	
	of processing started by			Synchronous function	
Format	#include "r_dk2_if.h"				
	void process_comp(u	int8_t id, int32	_t result);		
	Note: This function ca	an be given an	y name.		
	id	I	ID of circuit whose processing ha	s finished	
	result	I	R_DK2_SUCCESS:		
		I	Indicates that processing has cor	npleted successfully.	
]	R_DK2_ERR_DEVICE:		
		I	Indicates that a transfer error occ	urred while transferring	
			parameters set by the R_DK2_St	art function or while	
			transferring circuit I/O data.		
			R_DK2_ERR_STOPPED:		
			Indicates that while transferring p	-	
			R_DK2_Start function or while tra		
			the transfer was stopped by calling		
		j	function or the R_DK2_Inactivate	function.	
Return value	es None				
Description			d by the argument pprocess of the		
	provides notification when the processing started by R_DK2_Start function finishes. The				
			on is called is the same as the nu		
		n is called, unle	ess an event such as a forced unl	oad by the R_DK2_Unload	
	function occurs.				
	This function is executed in the interrupt context. This function must not call any DRP driver				
-	function.				
Note			R_DK2_ERR_DEVICE, reevalua		
	etc., for the allocation	of the parame	eters set by the R_DK2_Start fund	ction or circuit I/O data.	

5.9 R_DK2_GetStatus

R DK2	GetStatus	DRP driver API
	f circuit in DRP	Synchronous function
Format	#include "r_dk2_if.h"	·
	int32_t R_DK2_GetStatus(const	uint8_t id);
	id I	Specifies the ID of the circuit to be whose state is to be acquired.
Return value	es R_DK2_STATUS_LOADED :	Normal end.
		Indicates that the specified circuit is in the loaded state.
	R_DK2_STATUS_ACTICATE:	Normal end.
	D	Indicates that the specified circuit is in the activated state
	R_DK2_STATUS_STARTED :	Normal end.
		Indicates that the specified circuit is in the started state.
	R_DK2_STATUS_LOADING :	Normal end.
		Indicates that the specified circuit is in the loading state.
	R_DK2_ERR_ARG :	Abnormal end.
		This error is generated when the value of the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS :	Abnormal end.
		This error is generated when exclusive control by the OS fails.
Description	means that the function complete the circuit. A negative return value represents an error code. For informations of Individual Circuits. This API function uses OS functions are not executed a	of a circuit currently loaded in the DRP. A positive return value ed successfully, and the value returned indicates the state of the means that the function failed, and the value returned formation on circuit states in the DRP, refer to 6.2, State conality to provide exclusive control so that multiple DRP driver at the same time. If a failure occurs because resource cusive control, the value R_DK2_ERR_OS is returned and the
Note	None	

5.10 R_DK2_GetInfo

R_DK2	_GetInfo				DRP driver A	
Gets inforn	nation from configuration data	and che	ecks CRC.		Synchronous functi	
Format	#include "r_dk2_if.h" int32_t R_DK2_GetInfo(const void *const pconfig, config_info_t *const pinfo, const bool crc_check);					
	pconfig	I	Specifies the address of the configuration data from which information is obtained. The configuration data must be aligned with a 32-byte boundary. Specifies the address of the structure config_info_t type variable. This API function stores the following information from the configuration data in the members of the structure			
	pinfo	0				
			Member Name	Туре	Description	
			type	uint8_t	This area is reserved. The data stored here consists of zeros.	
			pname	char *	Stores a pointer to a character string of up to 31 bytes representing the circuit name.	
			ver	uint32_t	Stores the version of the configuration data.*1	
			cid	uint32_t	Stores a unique ID representing the circuit stored in the configuration data.	
			Note 1. Th follows:	e storage fo	ormat of the member ver is as	
			Bit Position	n Descr	iption	
			0 to 7	Stores	s the build number.	
			8 to 15	Stores	s the minor version.	
			16 to 23	Stores	the major version.	
			24 to 31		rea is reserved. The data stored consists of zeros.	
			For example	e, a ver valu	ue of 0x00010201 represents version	
	crc_check	I	•	n the config	ue whether or not a CRC check is guration data when getting	
Return valu	ues R_DK2_SUCCESS	:	Normal end	•		
	R_DK2_ERR_ARG	:	Abnormal end. This error is generated when pconfig has a val			
	R_DK2_ERR_FORMAT	:		nd. generated	NULL. when a format error is detected in	
	R_DK2_ERR_CRC	:	the configuration data. Abnormal end.			
					when the argument crc_check is s r is detected in the configuration	

data.

Description	This API function gets information from the configuration data at the address specified by the argument pconfig. It writes the information obtained from the configuration data to the address specified by the argument pinfo. This API function also performs a CRC check on the configuration data. If the CRC check fails, the value R_DK2_ERR_CRC is returned and an abnormal end occurs.
Note	If a value of R_DK2_ERR_FORMAT is returned, confirm that the address specified by the argument pconfig is the correct address of the configuration data.

5.11 R_DK2_GetVersion

R DK2 GetVersion

DRP driver API

Gets DRP driver version information

Synchronous function

Format

#include "r_dk2_if.h"

uint32_t R_DK2_GetVersion(void);

Return values DRP driver version

information

The storage format is as shown below.

Bit Position	Description
0 to 7	Stores the build number.
8 to 15	Stores the minor version.
16 to 23	Stores the major version.
24 to 31	This area is reserved. The data stored here consists of zeros.

For example, a return value of 0x00010201 represents version 1.21.

Description	This API function gets the version number of the DRP driver.
Note	None

RZ/A2M Group 6. State Transitions

6. State Transitions

6.1 State Transitions of the DRP Driver Overall

Figure 6.1 shows state transitions and the clock supply status of the DRP driver overall.

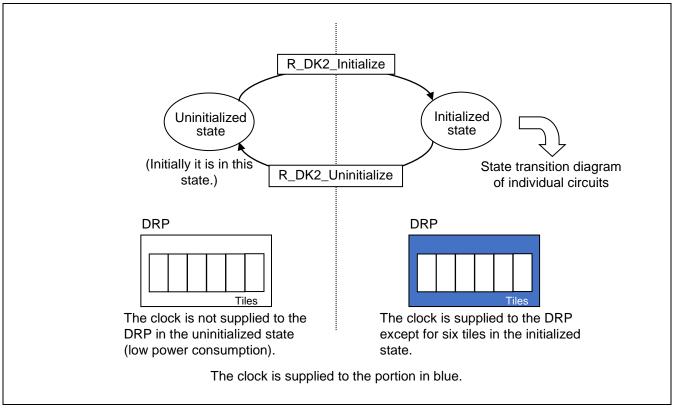


Figure 6.1 State Transitions and Clock Supply Status of DRP Driver Overall

RZ/A2M Group 6. State Transitions

6.2 State Transitions of Individual Circuits

Figure 6.2 shows state transitions and the clock supply status of individual circuits.

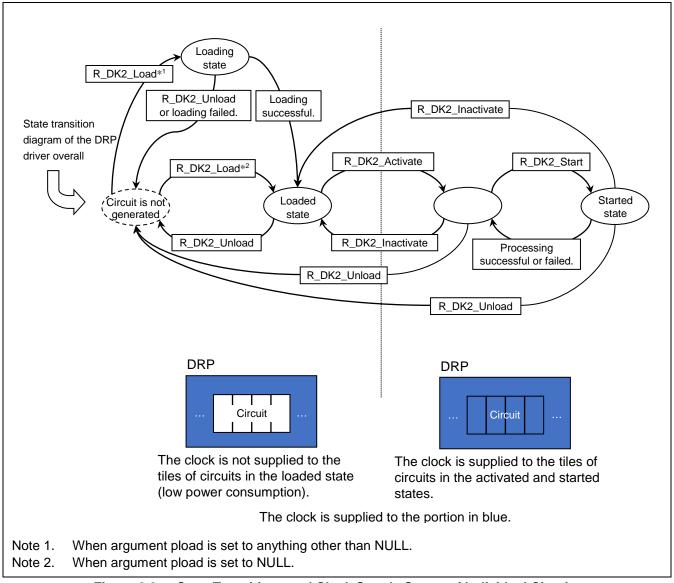


Figure 6.2 State Transitions and Clock Supply Status of Individual Circuits

RZ/A2M Group 7. Control Flowchart

7. Control Flowchart

Figure 7.1 is a flowchart of a DRP driver usage example.

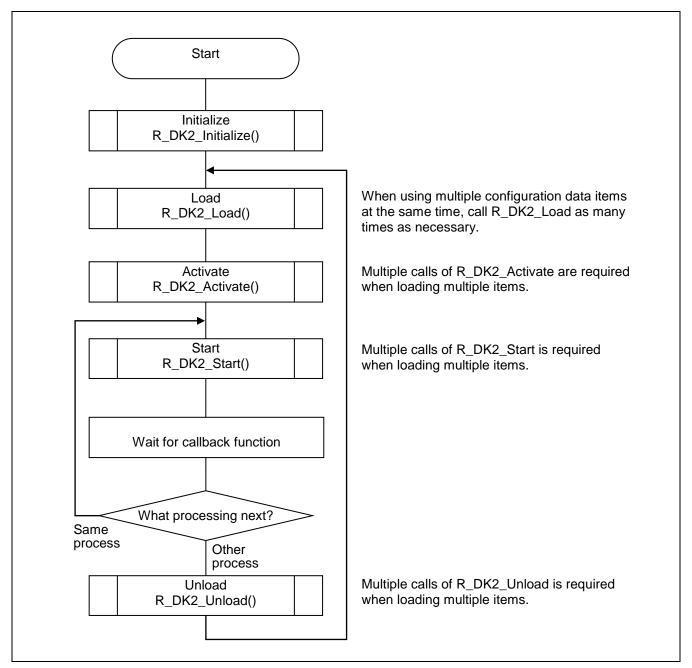


Figure 7.1 DRP Driver Usage Example

RZ/A2M Group 9. Reference Documents

8. OS-Dependent Portion

The OS-dependent portion of the DRP driver is separated from the rest as an OS abstraction layer. The DRP driver supports FreeRTOS via this OS abstraction layer.

The functionality provided by the DRP driver by means of the OS-dependent portion is support for reentrancy of API functions. Exclusive control employing the mutual exclusion (Mutex) capability of FreeRTOS is used to enable reentrancy for some of the API functions, as indicated in Table 8.1.

To implement reentrancy the DRP driver uses a single Mutex to provide exclusive control. When an API function supporting reentrancy is running and another API function supporting reentrancy is called, the second API function waits until the first API function finishes.

It is possible to use the macro MUTEX_WAIT defined in r_dk2_if.c to set the timeout duration during exclusive control. To specify the timeout duration, assign an integer between 0 and 0xFFFFFFFF to the macro MUTEX_WAIT. The setting value represents the timeout duration in millisecond units. A value of 0 means no wait. The default timeout duration setting is 100 milliseconds.

Table 8.1 Reentrancy Support of DRP Driver API Functions

API Function Name	Reentrancy Support	Page
R_DK2_Initialize	Reentrancy not supported	7
R_DK2_Uninitialize	Reentrancy not supported	8
R_DK2_Load	Reentrancy supported	9
R_DK2_Unload	Reentrancy supported	15
R_DK2_Activate	Reentrancy supported	16
R_DK2_Inactivate	Reentrancy supported	17
R_DK2_Start	Reentrancy supported	18
R_DK2_GetStatus	Reentrancy supported	20
R_DK2_GetInfo	Reentrancy not supported	21
R_DK2_GetVersion	Reentrancy not supported	23

RZ/A2M Group 9. Reference Documents

9. Reference Documents

User's Manual: Hardware

RZ/A2M Group User's Manual: Hardware (R01UH0746)

(Download the latest version of the manual from the Renesas Electronics website.)

User's Manual: Software

RZ/A2M Group DRP Library User's Manual (R01US0367)

(Download the latest version of the manual from the Renesas Electronics website.)

User's Manual: Development Environment

For the Renesas Electronics integrated development environment (e2 studio), please visit the Renesas

Electronics website to download the latest version.

Technical Update/Technical News

(Download the latest version of the update or news from the Renesas Electronics website.)

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